

## PATENT ASSIGNMENT

Electronic Version v1.1  
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SUBMISSION TYPE:	NEW ASSIGNMENT																		
NATURE OF CONVEYANCE:	ASSIGNMENT																		
<b>CONVEYING PARTY DATA</b>																			
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hiromitsu NAKASHIMA</td> <td>08/29/2013</td> </tr> <tr> <td>Toru KIMURA</td> <td>09/24/2013</td> </tr> <tr> <td>Yusuke ASANO</td> <td>09/24/2013</td> </tr> <tr> <td>Masafumi HORI</td> <td>08/29/2013</td> </tr> <tr> <td>Reiko KIMURA</td> <td>08/29/2013</td> </tr> <tr> <td>Kazuki KASAHARA</td> <td>09/12/2013</td> </tr> <tr> <td>Hiromu MIYATA</td> <td>09/24/2013</td> </tr> <tr> <td>Masafumi YOSHIDA</td> <td>08/29/2013</td> </tr> </tbody> </table>		Name	Execution Date	Hiromitsu NAKASHIMA	08/29/2013	Toru KIMURA	09/24/2013	Yusuke ASANO	09/24/2013	Masafumi HORI	08/29/2013	Reiko KIMURA	08/29/2013	Kazuki KASAHARA	09/12/2013	Hiromu MIYATA	09/24/2013	Masafumi YOSHIDA	08/29/2013
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<table border="1"> <tr> <td>Name:</td> <td>JSR CORPORATION</td> </tr> <tr> <td>Street Address:</td> <td>9-2, Higashi-Shinbashi 1-chome, Minato-ku</td> </tr> <tr> <td>City:</td> <td>Tokyo</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>105-8640</td> </tr> </table>		Name:	JSR CORPORATION	Street Address:	9-2, Higashi-Shinbashi 1-chome, Minato-ku	City:	Tokyo	State/Country:	JAPAN	Postal Code:	105-8640								
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<b>CORRESPONDENCE DATA</b>																			
Fax Number:	7035199958																		
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>																			
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Address Line 2:	Suite 322																		
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OP \$40.00 14037659

ATTORNEY DOCKET NUMBER:	P7274US00
NAME OF SUBMITTER:	Masayasu Mori
Signature:	/Masayasu Mori/
Date:	09/26/2013
	This document serves as an Oath/Declaration (37 CFR 1.63).
<b>Total Attachments: 8</b> source=P7274US00_DecAsn_filed#page1.tif source=P7274US00_DecAsn_filed#page2.tif source=P7274US00_DecAsn_filed#page3.tif source=P7274US00_DecAsn_filed#page4.tif source=P7274US00_DecAsn_filed#page5.tif source=P7274US00_DecAsn_filed#page6.tif source=P7274US00_DecAsn_filed#page7.tif source=P7274US00_DecAsn_filed#page8.tif	









**COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR  
DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)**

<b>Title of Invention</b>	RESIST PATTERN-FORMING METHOD, RESIST PATTERN-FORMING RADIATION-SENSITIVE RESIN COMPOSITION, AND RESIST FILM
<p>As the below named inventor, I hereby declare that:</p> <p>This declaration is directed to: <input checked="" type="checkbox"/> The attached application, or <input type="checkbox"/> United States application or PCT international application number _____ filed on _____</p> <p>The above-identified application was made or authorized to be made by me.</p> <p>I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.</p> <p>I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.</p> <p>I have reviewed and understand the contents of the application and am aware of the duty to disclose to the US Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR § 1.56.</p> <p align="center"><b>ASSIGNMENT</b></p> <p>For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, and transfer to <u>JSR CORPORATION</u>, having a principle place of business at <u>9-2, Higashi-Shinbashi 1-chome, Minato-ku, Tokyo 105-8640 Japan</u>, and its successors, assigns, and legal representatives, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue for the United States and all foreign countries (including the right to claim priority under the terms of the International Convention and any other relevant International Treaties and Arrangements from the aforesaid application), in and to any and all improvements that are disclosed in the above-noted application, and in and to any reissues, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that have been or shall be filed in the United States and all foreign countries on any of said improvements.</p> <p>I agree that I will communicate to the assignee or its representatives any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, and reissue applications, execute all necessary assignment papers to cause any and all Patents to be issued to the assignee, make all rightful oaths, and, generally do everything possible to aid said assignee, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.</p>	
LEGAL NAME OF INVENTOR (Given name FAMILY NAME)	
Inventor: <u>Reiko KIMURA</u>	Date: <u>2013. 8. 29</u>
Signature: <u>Reiko KIMURA</u>	

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<p><b>LEGAL NAME OF INVENTOR (Given name FAMILY NAME)</b></p> <p>Inventor: <u>Kazuki KASAHARA</u> Date: <u>12th September 2013</u></p> <p>Signature: <u>Kazuki KASAHARA</u></p>	

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Invention**

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LEGAL NAME OF INVENTOR (Given name FAMILY NAME)

Inventor: Hiromu MIYATA

Date: 2013/9/29

Signature: \_\_\_\_\_

宮田 拓

